

AN8818SB

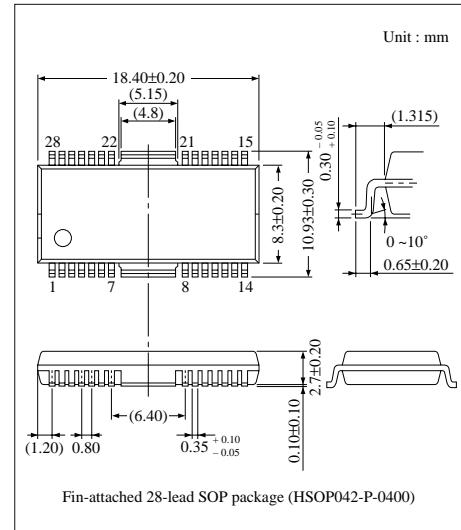
3ch. Linear Driver IC for CD/CD-ROM

■ Overview

The AN8818SB is a 3ch. driver using the power operational amplifier method. It employs the surface mounting type package superior in radiation characteristics.

■ Features

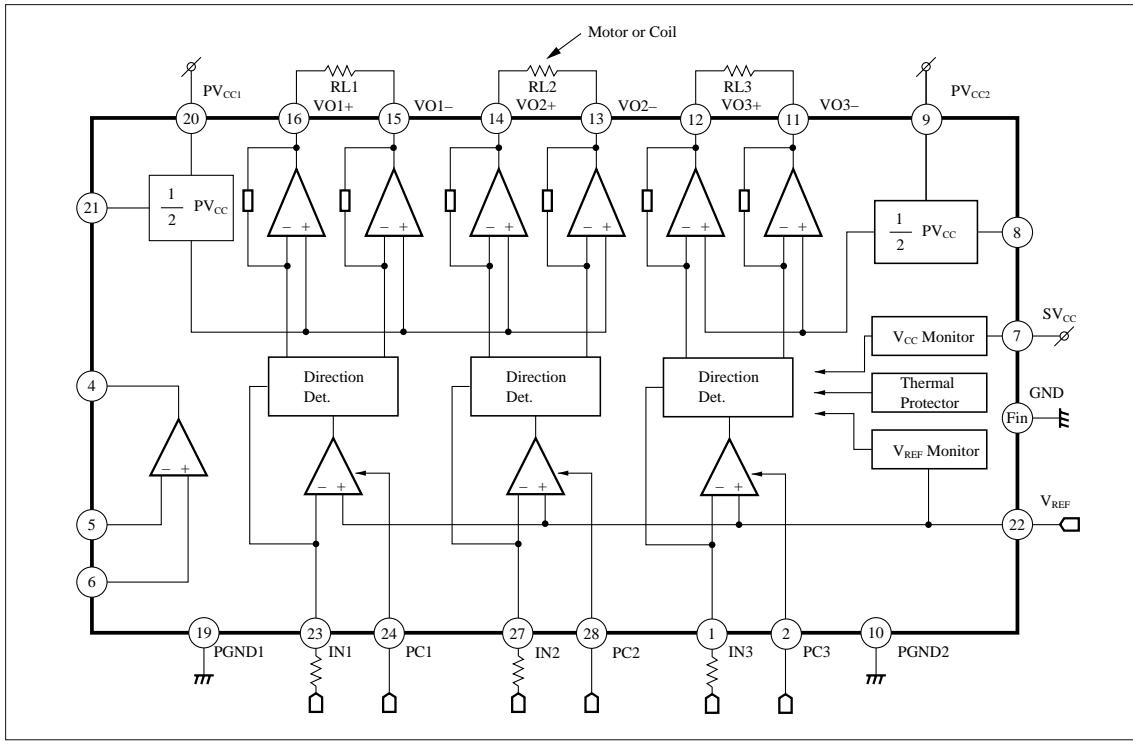
- Wide output D-range is available regardless of the reference voltage on the system
- Input/Output gain setting for the driver enabled by an external resistance
- 3ch. independently controllable PC (Power Cut) feature built-in
- Thermal shut down circuit (with hysteresis) built-in
- Proper heat of IC controllable by separating the output supply for 2ch. and one ch. and independently setting for them
- Accessory operational amplifier built-in
- Relatively easy pattern design by separating and concentrating the input line and output line



■ Application

Actuator for CD/CD-ROM, motor driver

■ Block Diagram



■ Pin Description

| Pin No. | Pin Name | Pin No. | Pin Name |
|---------|---|---------|--|
| 1 | Input Pin of Motor Driver 3 | 16 | Normal Rotation Output Pin of Motor Driver 1 |
| 2 | PC (Power Cut) Input Pin 3 | 17 | NC |
| 3 | NC | 18 | NC |
| 4 | Output Pin of Op-Amp. | 19 | GND 1 for Driver |
| 5 | Reverse Rotation Input Pin of Op-Amp. | 20 | V _{CC} 1 for Driver |
| 6 | Normal Rotation Input Pin of Op-Amp. | 21 | 1/2 PV _{CC} Output Pin 1 |
| 7 | V _{CC} | 22 | V _{REF} Input Pin |
| 8 | 1/2 PV _{CC} Output Pin 2 | 23 | Input Pin of Motor Driver 1 |
| 9 | V _{CC} 2 for Driver | 24 | PC (Power Cut) Input Pin 1 |
| 10 | GND 2 for Driver | 25 | NC |
| 11 | Reverse Rotation Output Pin of Motor Driver 3 | 26 | NC |
| 12 | Normal Rotation Output Pin of Motor Driver 3 | 27 | Input Pin of Motor Driver 2 |
| 13 | Reverse Rotation Output Pin of Motor Driver 2 | 28 | PC (Power Cut) Input Pin 2 |
| 14 | Normal Rotation Output Pin of Motor Driver 2 | Fin | GND |
| 15 | Normal Rotation Output Pin of Motor Driver 1 | — | — |

■ Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Rating | Rating |
|------------------------------------|------------------|------------|--------|
| Supply Voltage | V _{CC} | 18 | V |
| Supply Current | I _{CC} | — | mA |
| Power Dissipation ^{Note)} | P _D | 3140 | mW |
| Operating Ambient Temperature | T _{opr} | -30 ~ +85 | °C |
| Storage Temperature | T _{stg} | -55 ~ +150 | °C |

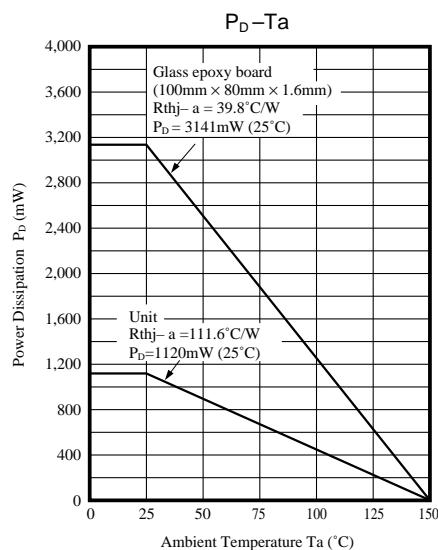
Note) For surface mounting on 100 × 80 × 1.6 mm double face glass epoxy board.

■ Recommended Operating Range (Ta=25°C)

| Parameter | Symbol | Range |
|--------------------------------|---------------------------------------|------------|
| Operating Supply Voltage Range | SV _{CC} ^{Note)} | 4.5V ~ 14V |
| | PV _{CC1} , PV _{CC2} | |

Note) Set SV_{CC} to the maximum electric potential.

■ Characteristic Curve

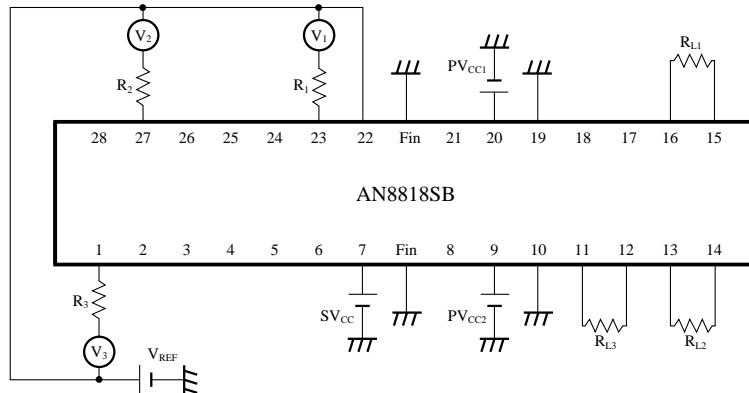


■ Electrical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | min. | typ. | max. | Uni |
|--|-------------------|---|------|-------|------|-----|
| Total Circuit Current | I _{tot} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | 5 | 10 | 15 | mA |
| Drivers 1 and 4 | | | | | | |
| Input Offset Voltage | V _{IOF} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | -10 | — | 10 | mV |
| Output Offset Voltage | V _{OOF} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | -50 | — | 50 | mV |
| Gain | G | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | 18 | 20 | 22 | dB |
| Maximum Output Amplitude (+) | V _{L+} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | 4.4 | 5.0 | — | V |
| Maximum Output Amplitude (-) | V _{L-} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | — | -5.0 | -4.4 | V |
| Threshold H | V _{PCH} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | 2.0 | — | — | V |
| Threshold L | V _{PCL} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V R _L =8Ω, R _{IN} =10kΩ | — | — | 0.3 | V |
| Reset Circuit | | | | | | |
| Reset Operation Release Supply Voltage | V _{RST} | I _{IN} =10μA, R _{IN} =10kΩ | 3.0 | 3.2 | 3.3 | V |
| V _{REF} Detection | V _{REF} | | 2.0 | — | — | V |
| OP Amp. | | | | | | |
| Input Offset Voltage | V _{OF} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | -5 | — | 5 | mV |
| Input Bias Current | I _{BOP} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | — | 150 | 500 | nA |
| High-Level Output Voltage | V _{OH} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | 6.0 | — | — | V |
| Low-Level Output Voltage | V _{OL} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | — | — | 1.7 | V |
| Output Drive Current Sink | I _{SIN} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | 2.0 | — | — | mA |
| Output Drive Current Source | I _{SOU} | PV _{CC1} =PV _{CC2} =SV _{CC} =8V | 2.0 | — | — | mA |
| Heat Protection Circuit | | | | | | |
| Operation Temperature Equilibrium Value ^{Note 1)} | T _{THD} | | (—) | (180) | (—) | °C |
| Operation Temperature Hysteresis Width ^{Note 1)} | DT _{THD} | | (—) | (45) | (—) | °C |

Note 1) Characteristic value in parentheses is a reference value for design but not a guaranteed value.

■ Cautions for use



When the AN8818SB is used, take into account the following cautions and follow the power dissipation characteristic curve.

(1) Load current, I_{P1} flowing in loads R_{L1} and R_{L2} is supplied through Pin20.

$$I_{P1} = \frac{|V_{16}-V_{15}|}{R_{L1}} + \frac{|V_{14}-V_{13}|}{R_{L2}}$$

(2) Load current, I_{P2} flowing in load R_{L3} is supplied through Pin9.

$$I_{P2} = \frac{|V_{12}-V_{11}|}{R_{L3}}$$

(3) Dissipation increase (ΔP_d) inside the IC (power output stage) caused by loads R_{L1} , R_{L2} , and R_{L3} is as follows ;

$$\begin{aligned} \Delta P_d = & (PV_{CC1} - |V_{16}-V_{15}|) \times \frac{|V_{16}-V_{15}|}{R_{L1}} + (PV_{CC2} - |V_{14}-V_{13}|) \times \frac{|V_{14}-V_{13}|}{R_{L2}} \\ & + (PV_{CC2} - |V_{12}-V_{11}|) \times \frac{|V_{12}-V_{11}|}{R_{L3}} \end{aligned}$$

(4) Dissipation increase (ΔP_s) inside the IC (signal block supplied from Pin7 caused by loads R_{L1} , R_{L2} and R_{L3} is almost as follows:

$$\begin{aligned} \Delta P_s = 3 \left\{ & \frac{V_1}{R_1} (2SV_{CC} + |V_{16}-V_{15}|) + \frac{V_2}{R_2} (2SV_{CC} + |V_{14}-V_{13}|) \\ & + \frac{V_3}{R_3} (2SV_{CC} + |V_{12}-V_{11}|) \right\} \end{aligned}$$

(5) Dissipation increase during driver running is $\Delta P_d + \Delta P_s$.

(6) Inside loss under no load (P_{d1}) is almost as follows ;

$$P_{d1} = SV_{CC} \times I(SV_{CC}) + PV_{CC1} \times I(PV_{CC1}) + PV_{CC2} \times I(PV_{CC2})$$

(7) Entire IC inside loss (P_d) is almost as follows ;

$$P_d = P_{d1} + \Delta P_d + \Delta P_s$$